



SSD20N15B-C
20A, 150V, R_{DS(ON)} 90mΩ
N-Ch Enhancement Mode Power MOSFET

RoHS Compliant Product
A suffix of “-C” specifies halogen free

DESCRIPTION

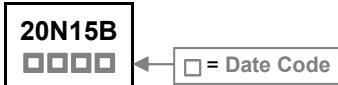
The SSD20N15B-C is the highest performance trench N-Ch MOSFETs with extreme high cell density, which provide excellent $R_{DS(ON)}$ and gate charge for most of the synchronous buck converter applications.

The SSD20N15B-C meet the RoHS and Green Product requirement with full function reliability approved.

FEATURES

- Advanced High Cell Density Trench Technology
 - Super Low Gate Charge
 - Green Device Available

MARKING

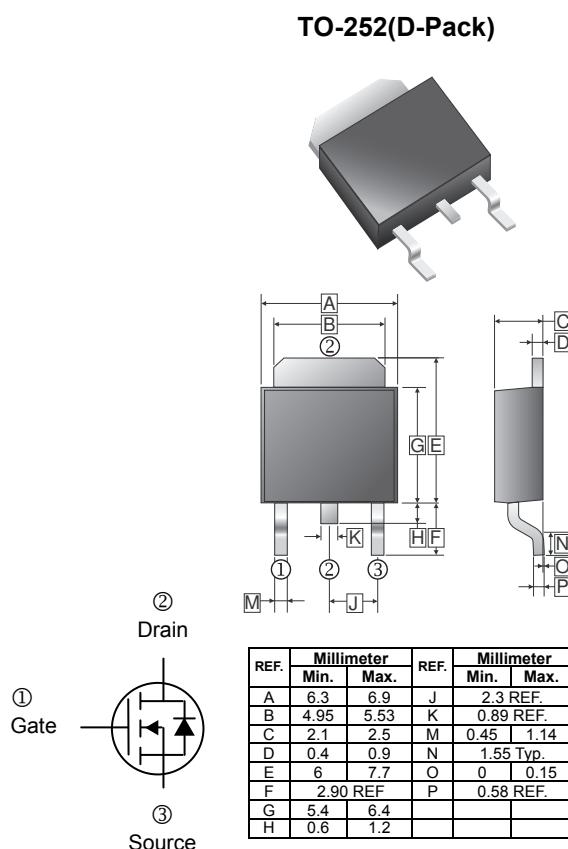


PACKAGE INFORMATION

Package	MPQ	Leader Size
TO-252	2.5K	13 inch

ORDER INFORMATION

Part Number	Type
SSD20N15B-C	Lead (Pb)-free and Halogen-free



ABSOLUTE MAXIMUM RATINGS

Parameter	Symbol	Ratings	Unit
Drain-Source Voltage	V _{DS}	150	V
Gate-Source Voltage	V _{GS}	±20	V
Continuous Drain Current ¹ , @ V _{GS} =10V	T _C =25°C	I _D	20
	T _C =100°C		14
Pulsed Drain Current ²	I _{DM}	40	A
Total Power Dissipation ³	T _C =25°C	P _D	72.6 W
Operating Junction and Storage Temperature Range	T _J , T _{STG}	-55~150	°C
Thermal Resistance Ratings			
Maximum Thermal Resistance Junction-Ambient ¹	R _{θJA}	60	°C/W
Maximum Thermal Resistance Junction-Case ¹	R _{θJC}	1.72	

ELECTRICAL CHARACTERISTICS ($T_J=25^\circ\text{C}$ unless otherwise specified)

Parameter	Symbol	Min.	Typ.	Max.	Unit	Test Conditions
Drain-Source Breakdown Voltage	BV_{DSS}	150	-	-	V	$\text{V}_{\text{GS}}=0, \text{I}_D=250\mu\text{A}$
Gate Threshold Voltage	$\text{V}_{\text{GS(th)}}$	1.2	-	2.5	V	$\text{V}_{\text{DS}}=\text{V}_{\text{GS}}, \text{I}_D=250\mu\text{A}$
Forward Transconductance	g_{fs}	-	33	-	S	$\text{V}_{\text{DS}}=5\text{V}, \text{I}_D=10\text{A}$
Gate-Source Leakage Current	I_{GSS}	-	-	± 100	nA	$\text{V}_{\text{GS}}= \pm 20\text{V}$
Drain-Source Leakage Current	I_{DSS}	-	-	1	μA	$\text{V}_{\text{DS}}=120\text{V}, \text{V}_{\text{GS}}=0$
		-	-	5		$\text{V}_{\text{DS}}=120\text{V}, \text{V}_{\text{GS}}=0$
Static Drain-Source On-Resistance ²	$\text{R}_{\text{DS(ON)}}$	-	-	90	$\text{m}\Omega$	$\text{V}_{\text{GS}}=10\text{V}, \text{I}_D=10\text{A}$
		-	-	110		$\text{V}_{\text{GS}}=4.5\text{V}, \text{I}_D=10\text{A}$
Total Gate Charge	Q_g	-	25.1	-	nC	$\text{I}_D=10\text{A}$ $\text{V}_{\text{DS}}=75\text{V}$ $\text{V}_{\text{GS}}=4.5\text{V}$
Gate-Source Charge	Q_{gs}	-	6.8	-		
Gate-Drain Change	Q_{gd}	-	12.6	-		
Turn-on Delay Time	$\text{T}_{\text{d(on)}}$	-	13	-	nS	$\text{V}_{\text{DD}}=75\text{V}$ $\text{I}_D=10\text{A}$ $\text{V}_{\text{GS}}=10\text{V}$ $\text{R}_G=3.3\Omega$
Rise Time	T_r	-	8.2	-		
Turn-off Delay Time	$\text{T}_{\text{d(off)}}$	-	25	-		
Fall Time	T_f	-	11	-		
Input Capacitance	C_{iss}	-	2285	-	pF	$\text{V}_{\text{GS}}=0$ $\text{V}_{\text{DS}}=25\text{V}$ $f=1\text{MHz}$
Output Capacitance	C_{oss}	-	110	-		
Reverse Transfer Capacitance	C_{rss}	-	83	-		
Source-Drain Diode						
Continuous Source Current ¹	I_s	-	-	20	A	
Pulsed Source Current ²	I_{SM}	-	-	40		
Diode Forward Voltage ²	V_{SD}	-	-	1.2	V	$\text{V}_{\text{GS}}=0, \text{I}_s=1\text{A}, T_J=25^\circ\text{C}$
Reverse Recovery Time	t_{rr}	-	37	-	nS	$\text{I}_F=10\text{A}, \text{dI}/\text{dt}=100\text{A}/\mu\text{s}$ $T_J=25^\circ\text{C}$
Reverse Recovery Charge	Q_{rr}	-	263	-	nC	

Notes:

1. Surface Mounted on 1inch² FR4 Board with 2OZ copper.
2. The data tested by pulsed, Pulse Width $\leq 300\mu\text{s}$, Duty Cycle $\leq 2\%$.
3. The power dissipation is limited by 150°C , junction temperature.

TYPICAL CHARACTERISTICS CURVE

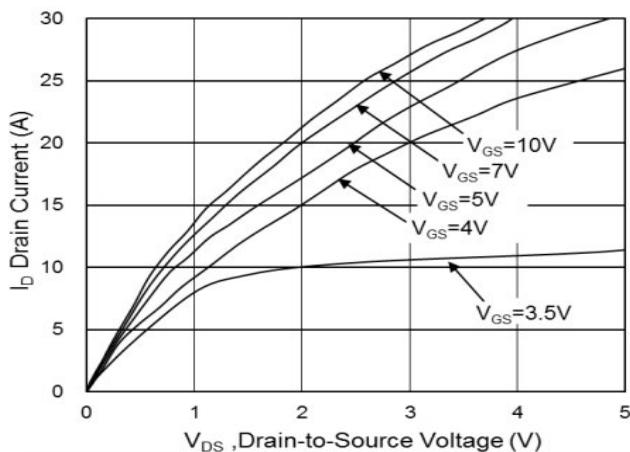


Fig.1 Typical Output Characteristics

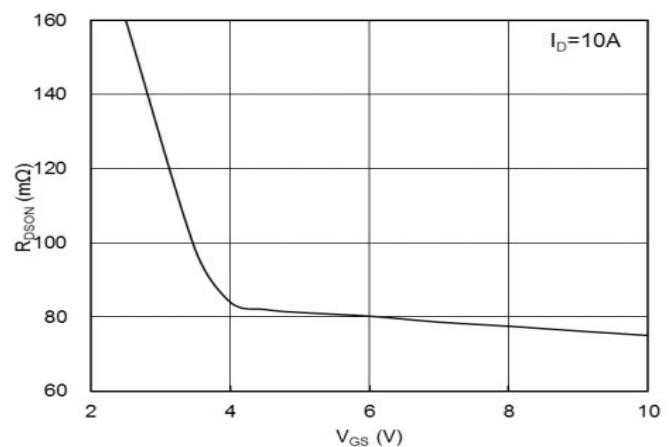


Fig.2 On-Resistance vs. Gate-Source Voltage

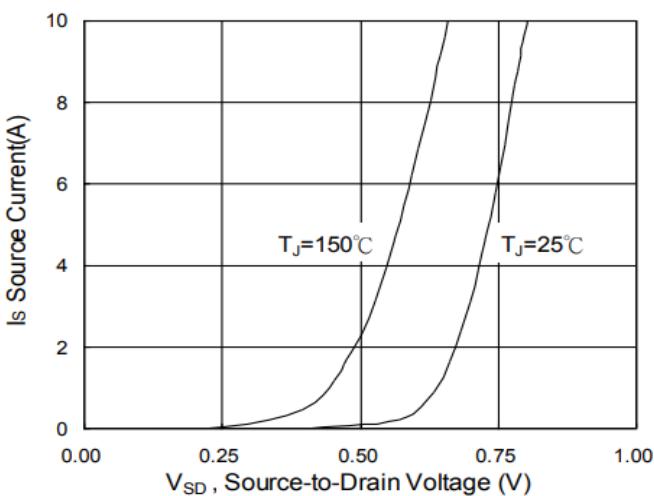


Fig.3 Forward Characteristics of Reverse

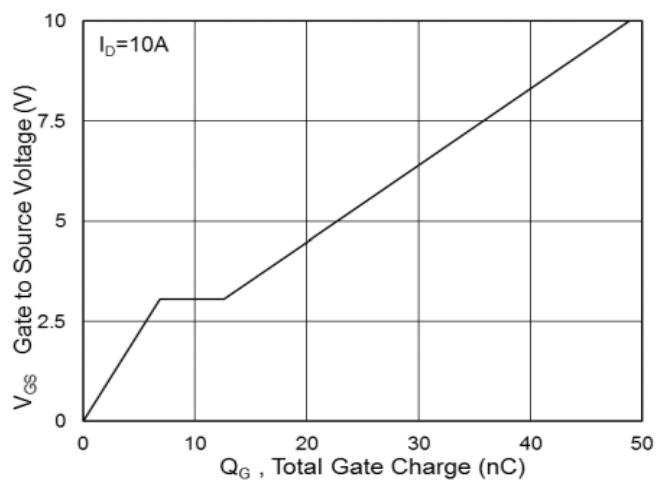


Fig.4 Gate-Charge Characteristics

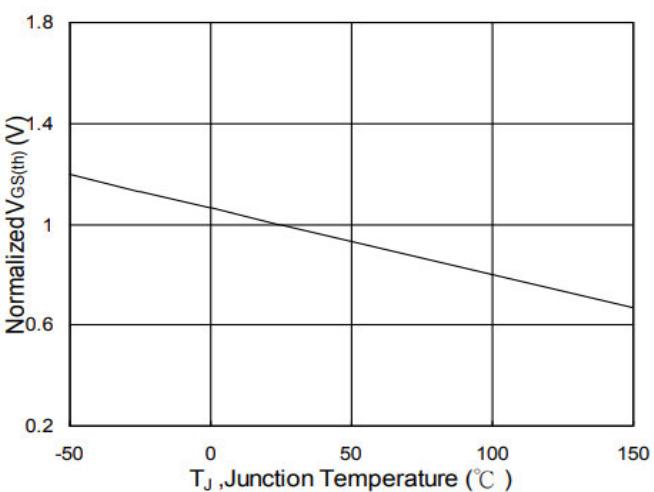


Fig.5 Normalized $V_{GS(th)}$ vs. T_J

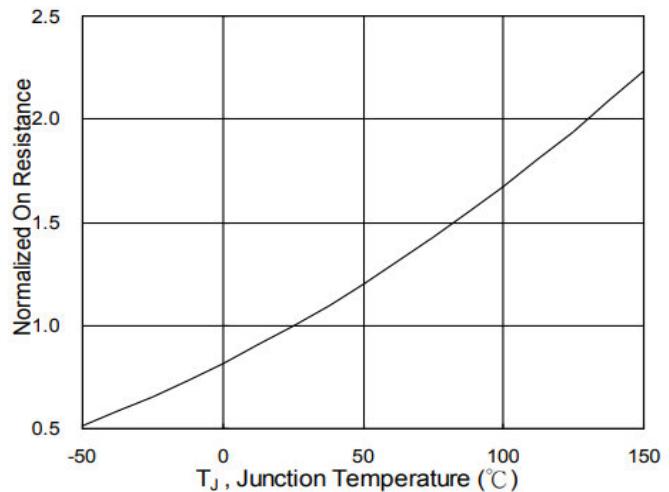


Fig.6 Normalized $R_{DS(on)}$ vs. T_J

TYPICAL CHARACTERISTICS CURVE

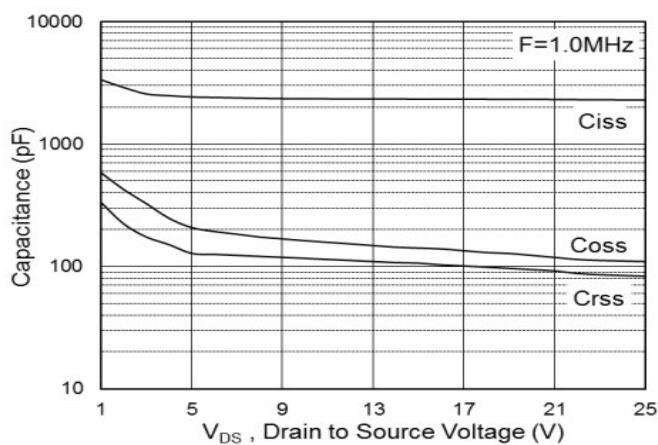


Fig.7 Capacitance

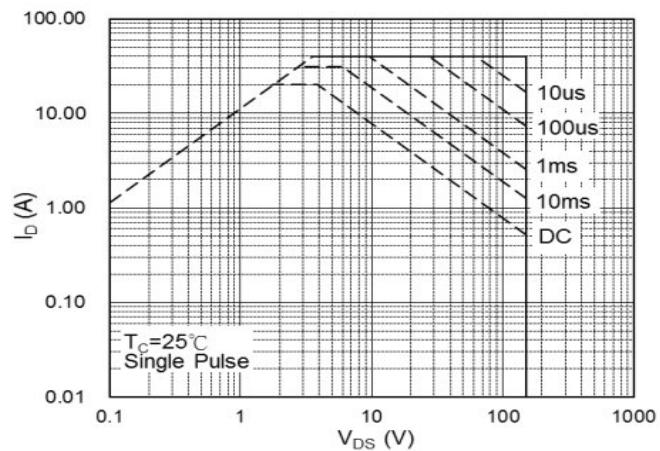


Fig.8 Safe Operating Area

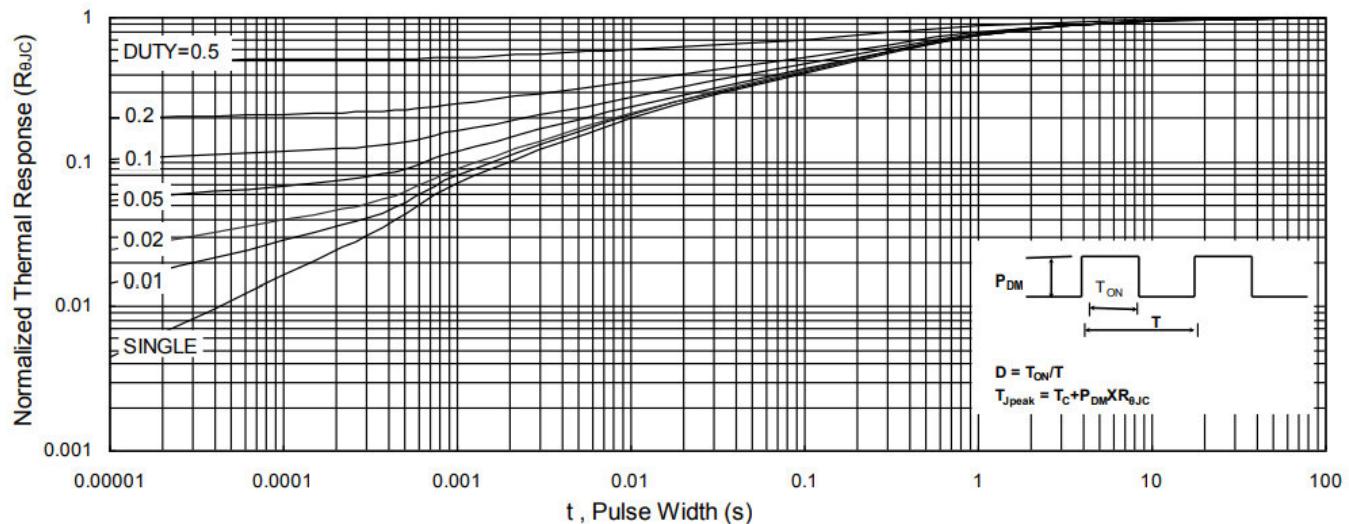


Fig.9 Normalized Maximum Transient Thermal Impedance

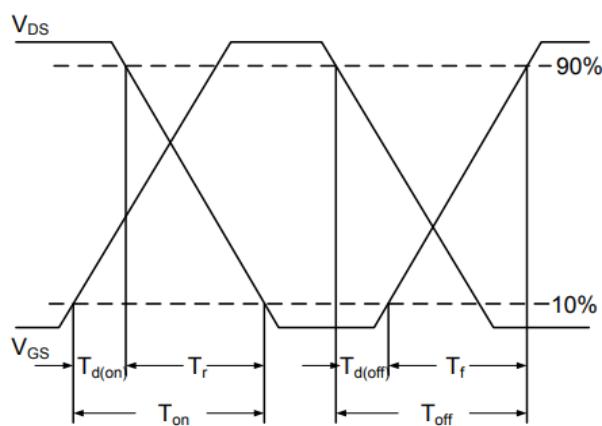


Fig.10 Switching Time Waveform

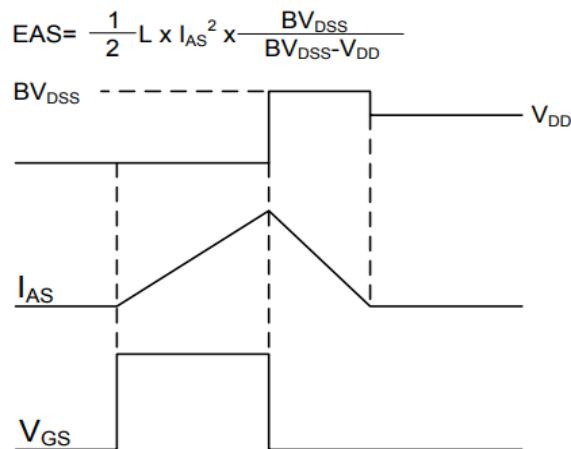


Fig.11 Unclamped Inductive Switching Waveform